XP151A11B0MR-G

ETR1117_003

Power MOSFET

■GENERAL DESCRIPTION

The XP151A11B0MR-G is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

In order to counter static, a gate protect diode is built-in.

The small SOT-23 package makes high density mounting possible.

■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

Low On-State Resistance : Rds(on) = 0.12Ω @ Vgs = 10V

: Rds(on) = 0.17Ω @ Vgs = 4.5V

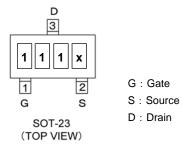
Ultra High-Speed Switching Gate Protect Diode Built-in Driving Voltage : 4.5V **N-Channel Power MOSFET**

DMOS Structure

Small Package : SOT-23

Environmentally Friendly: EU RoHS Compliant, Pb Free

■ PIN CONFIGURATION/ **MARKING**



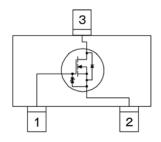
^{*} x represents production lot number.

■PRODUCT NAMES

PRODUCTS	PACKAGE	ORDER UNIT		
XP151A11B0MR	SOT-23	3,000/Reel		
XP151A11B0MR-G ^(*)	SOT-23	3,000/Reel		

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	Vdss	30	V
Gate - Source Voltage	Vgss	±20	V
Drain Current (DC)	ld	1	Α
Drain Current (Pulse)	ldp	4	Α
Reverse Drain Current	ldr	1	Α
Channel Power Dissipation *	Pd	0.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55~150	°C

^{*} When implemented on a ceramic PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics $Ta = 25^{\circ}C$

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds= 30V, Vgs= 0V	-	-	10	μΑ
Gate-Source Leak Current	Igss	Vgs= ±20V, Vds= 0V	-	-	±10	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	1.0	-	3.0	V
Drain-Source On-State Resistance *1	Rds(on)	Id= 0.5A, Vgs= 10V	-	0.09	0.12	Ω
Drain-Source On-State Resistance		Id= 0.5A, Vgs= 4.5V	-	0.13	0.17	Ω
Forward Transfer Admittance *1	Yfs	Id= 0.5A, Vds= 10V	-	2.4	1	S
Body Drain Diode Forward Voltage	Vf	If= 1A, Vgs= 0V	-	0.8	1.1	V

^{*1} Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f=1MHz	-	150	-	pF
Output Capacitance	Coss		-	90	-	pF
Feedback Capacitance	Crss		-	30	-	pF

Switching Characteristics

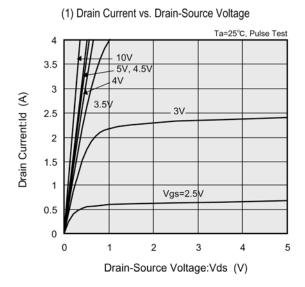
Ta = 25°C

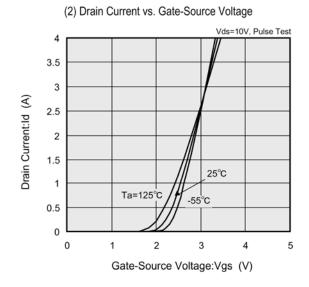
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id= 0.5A Vdd= 10V	1	10	ı	ns
Rise Time	tr		•	15	ı	ns
Turn-Off Delay Time	td (off)			25		ns
Fall Time	tf		-	45	-	ns

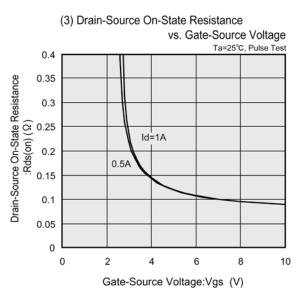
Thermal Characteristics

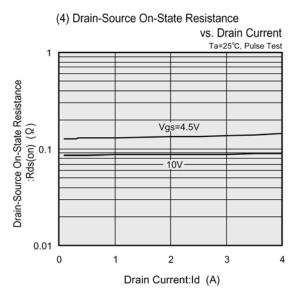
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	250	-	°C/W

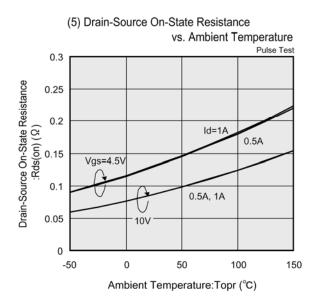
■TYPICAL PERFOMANCE CHARACTERISTICS

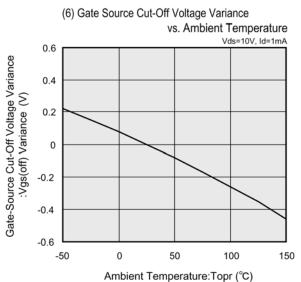




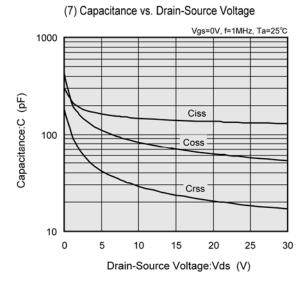


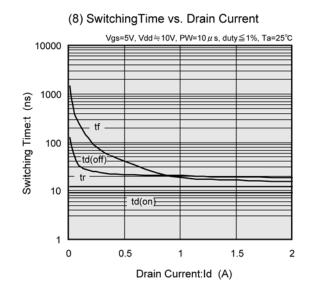


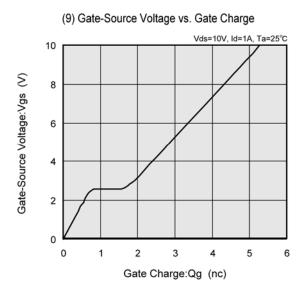


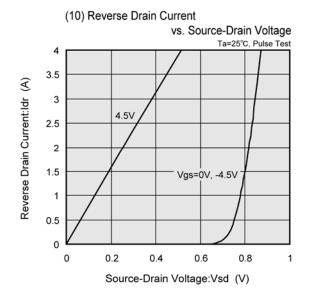


■TYPICAL PERFOMANCE CHARACTERISTICS (Continued)

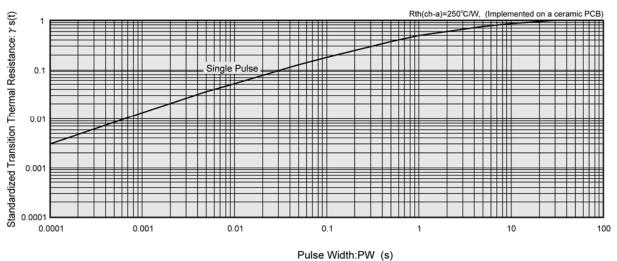








(11) Standardized transition Thermal Resistance vs. Pulse Width



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